

**具备1.65V至5.5V I/O接口的宽电源输入
RS-485收发器**

UM13430DA DFN10 3.0×3.0

描述

UM13430DA是一款输入电压范围为3.0V至5.5V的RS-485收发器，满足当今通信、基础设施和工业设备环境中日益增长的系统设计要求。这是一款宽输入电源（3.0V至5.5V）芯片，最大数据传输速率为10Mbps，具有1.65V至5.5V I/O逻辑电源，简化了多电压系统接口要求。

UM13430DA接收器包含一个完整的失效保护电路，当接收器输入开路、短路或悬空时，保证接收器输出逻辑高电平。UM13430DA接收器输入阻抗至少为96kΩ（1/8单位负载），允许总线连接多达256个节点。

UM13430DA驱动器有短路检测和热关断保护，在关断或断电时保持高阻态。UM13430DA没有压摆限制，适用于数据速率高达10Mbps的高速应用。

UM13430DA可进入仅1μA的低电流关断模式，从而极大地节省了功耗。

UM13430DA是一款半双工器件，最大数据传输速率为10Mbps，并采用10引脚DFN封装。

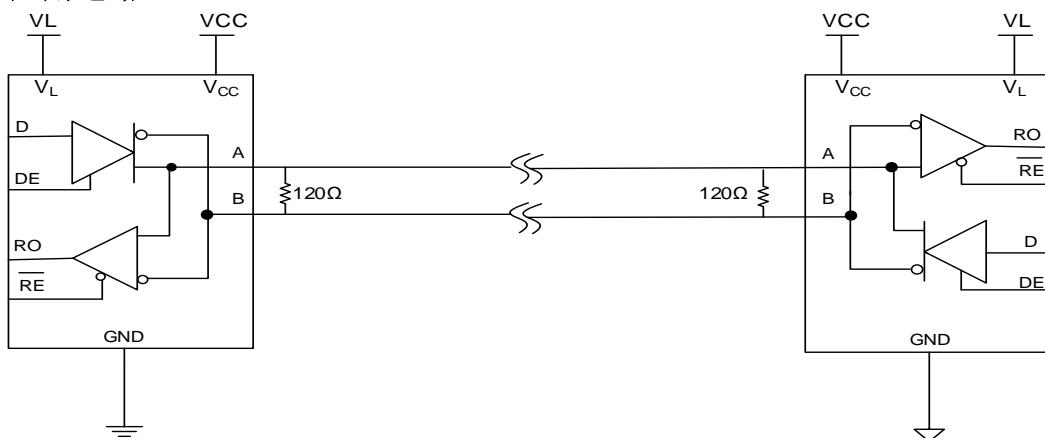
应用

- 电信基础设施
- 高速数据链路
- 低压μC通信
- 工业控制设备
- 建筑安全和自动化

特性

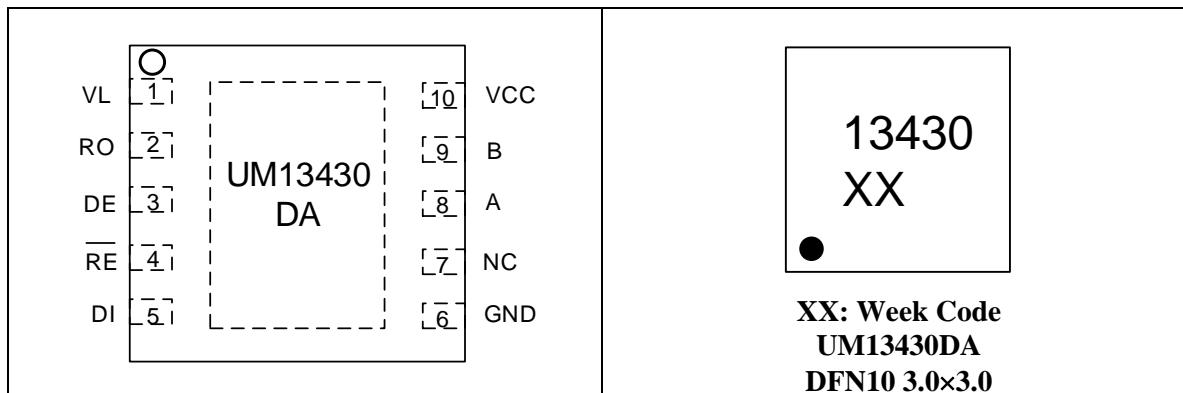
- 宽输入电源电压范围：+3.0V至+5.5V
- I/O逻辑接口VL引脚电压范围：1.65V至5.5V
- 最大数据传输速率10Mbps
- 1/8负载，允许总线上挂接256个收发器
- RS-485总线引脚具有稳健的ESD保护
- 驱动器短路限制和过载保护热关断
- 工作温度范围：-40 °C至85 °C
- 无铅(RoHS6)DFN封装

典型应用电路



Pin Configurations

Top View



Pin Description

| Pin Number | Symbol | Description |
|------------|-----------------|---|
| 1 | V _L | I/O power supply, sets the logic levels for RO, DE, \overline{RE} and DI |
| 2 | RO | Receiver Output |
| 3 | DE | Driver enable, driver active when DE = 1, disabled when DE = 0 |
| 4 | \overline{RE} | Receiver enable, receiver is disabled when $\overline{RE} = 1$, enabled when $\overline{RE} = 0$ |
| 5 | DI | Driver input |
| 6 | GND | Ground |
| 7 | NC | No connection, can be connected to ground |
| 8 | A | RS-485 half-duplex non-inverting receiver input and non-inverting driver output |
| 9 | B | RS-485 half-duplex inverting receiver input and inverting driver output |
| 10 | V _{CC} | Power supply |

Ordering Information

| Part Number | Packaging Type | Marking Code | Shipping Qty |
|-------------|----------------|--------------|----------------------------|
| UM13430DA | DFN10 3.0x3.0 | 13430 | 3000pcs/13Inch Tape & Reel |

Absolute Maximum Ratings (Note 1)

| Symbol | Parameter | Value | Unit |
|--|--|-----------------------------|-------------|
| V _{CC} | V _{CC} Supply Voltage | -0.3 to +6.0 | V |
| V _L | Logic Interface Voltage | -0.3 to +6.0 | V |
| V _{DE} , V _{DI} , V _{/RE} | Logic Input Voltage | -0.3 to +6.0 | V |
| V _{RO} | Receiver Output Voltage | -0.3 to V _L +0.3 | V |
| V _A /V _B | Driver Output Voltage/Receiver Input Voltage | -7.5 to +12.5 | V |
| T _{OP} | Operating Temperature Range | -40 to +85 | °C |
| T _J | Operating Junction Temperature | -40 to +125 | °C |
| T _{STG} | Storage Temperature Range | -65 to +150 | °C |
| T _L | Lead Temperature (Soldering, 10s) | +260 | °C |

Note 1: Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

Package Thermal Impedance

| Symbol | Parameter | Value | Unit |
|-----------------|--|--------------|-------------|
| θ _{JA} | Junction-to-ambient thermal resistance | 41 | °C/W |
| θ _{JC} | Junction-to-case thermal resistance | 9 | °C/W |

ESD Rating

| Symbol | Parameter | Value | Unit |
|----------------|--|--------------|-------------|
| ESD Protection | HBM - Human Body Model (RS-485 bus pins A, B) | ±8 | kV |
| | HBM - Human Body Model (all other pins) | ±4 | |

Electrical Characteristics

($V_{CC} = +3V$ to $+5.5V$, $V_L = +1.65V$ to V_{CC} , $T_A = -40^\circ C$ to $+85^\circ C$, unless otherwise noted.)

| Symbol | Parameter | Test Conditions | Min | Typ | Max | Unit |
|------------------------------------|---|--|-------------|------------|-------------|------------|
| Power Supply | | | | | | |
| V_{CC} | Supply-Voltage Range | | 3.0 | | 5.5 | V |
| V_L | Supply-Voltage Range | | 1.65 | | V_{CC} | |
| I_{CC} | Supply Current | | | | 2 | mA |
| I_{SHDN} | Supply Current in Shutdown Mode | | | 1 | 10 | μA |
| Driver DC Characteristics | | | | | | |
| V_{OD} | Differential Driver Output | Figure1 $R_L=54\ \Omega$, $V_{CC}=3.3V$ | 1.5 | | V_{CC} | V |
| | | $R_L=54\ \Omega$, $V_{CC}=4.5V$ | 2 | | V_{CC} | V |
| ΔV_{OD} (Note1) | Change in Magnitude of Differential Output Voltage | Figure1, $R_L=54\ \Omega$ | -0.2 | | 0.2 | V |
| V_{OC} | Driver Common Mode Output Voltage (Steady State) | Figure1, $R_L=54\ \Omega$ | | $V_{CC}/2$ | 3 | V |
| ΔV_{OC} (Note1) | Change in Driver Common Mode Output Voltage | Figure1, $R_L=54\ \Omega$ | -0.2 | | 0.2 | V |
| $I_{A, B}$ | Input Current (A or B) | $V_{OUT}=12V$, $DE=0V$, $V_{CC}=0V$ or $5.5V$ | | | 125 | μA |
| | | $V_{OUT}=-7V$, $DE=0V$, $V_{CC}=0V$ or $5.5V$ | -100 | | | μA |
| I_{OSD} (Note2) | Driver short circuit output current | $-7V \leq V_{OUT} \leq 12V$ | -250 | | 250 | mA |
| Receiver DC Characteristics | | | | | | |
| V_{TH} | Receiver Differential Threshold Voltage (V_A-V_B) | $-7V \leq V_{CM} \leq 12V$ | -200 | | -50 | mV |
| ΔV_{TH} | Receiver Input Hysteresis | $V_{CM}=0V$ | | 25 | | mV |
| R_{IN} | Receiver Input Resistance | $-7V \leq V_{CM} \leq 12V$ | 96 | | | k Ω |
| I_{OSR} | Receiver Output Short Circuit Current | $0V \leq V_{RO} \leq V_L$ | -100 | | 100 | mA |
| I_{OZR} | High-Z receiver output current | $0V \leq V_{OUT} \leq V_L$ | -1 | | 1 | μA |
| Logic Input and Output | | | | | | |
| V_{IH} | Logic Input thresholds (DI, DE, RE) | Logic Input High | $2/3 * V_L$ | | | V |
| V_{IL} | $1.65V \leq V_L \leq 5.5V$ & $V_L \leq V_{CC}$ | Logic Input Low | | | $1/3 * V_L$ | V |
| V_{HYS} | Input Hysteresis (DI, DE, RE) | | | 300 | | mV |
| I_{IN1} | Logic Input Current | DE, DI, RE | -1 | | 1 | μA |
| V_{OH} | Receiver Output High Voltage (RO) | $I_{OUT}=-1mA$ | $V_L-0.6$ | | | V |
| V_{OL} | Receiver Output Low Voltage (RO) | $I_{OUT}=1mA$ | | | 0.4 | V |

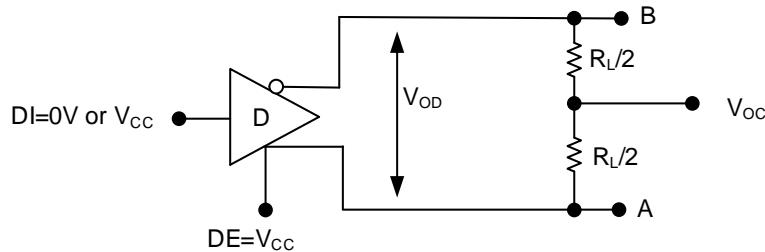
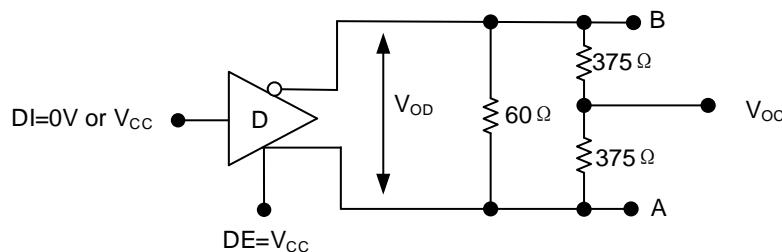
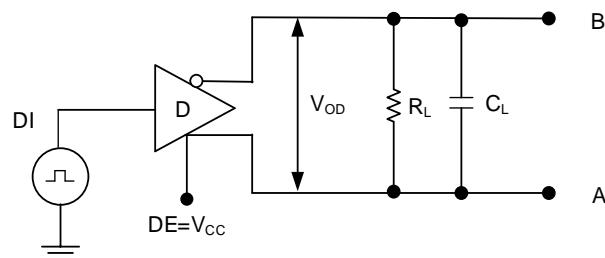
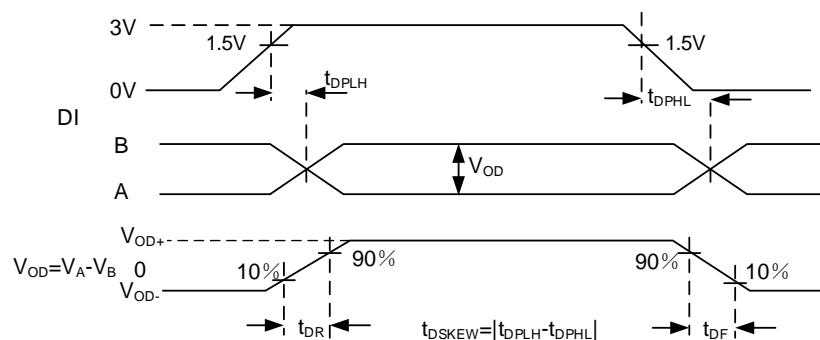
Note1 : ΔV_{OD} and ΔV_{OC} are the changes in V_{OD} and V_{OC} , respectively, when the DI input changes state.

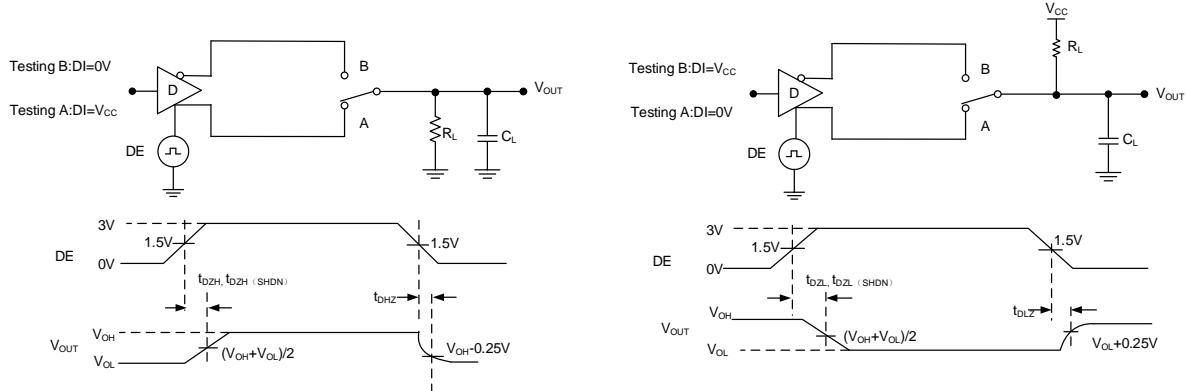
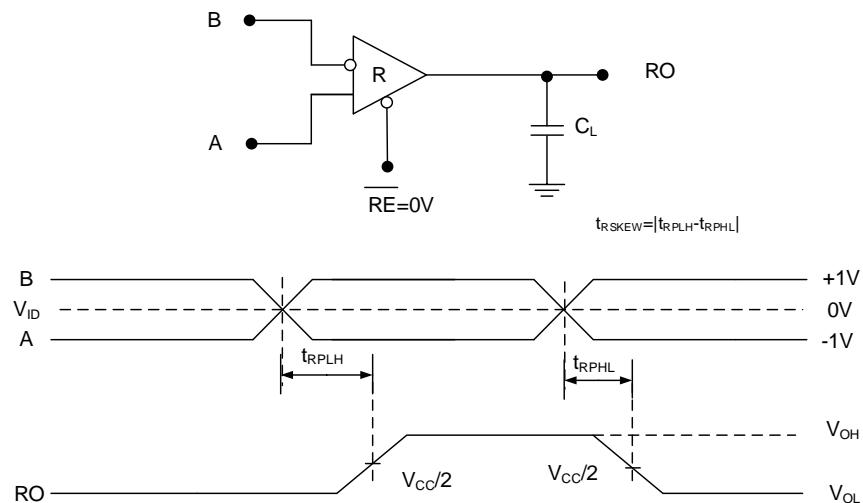
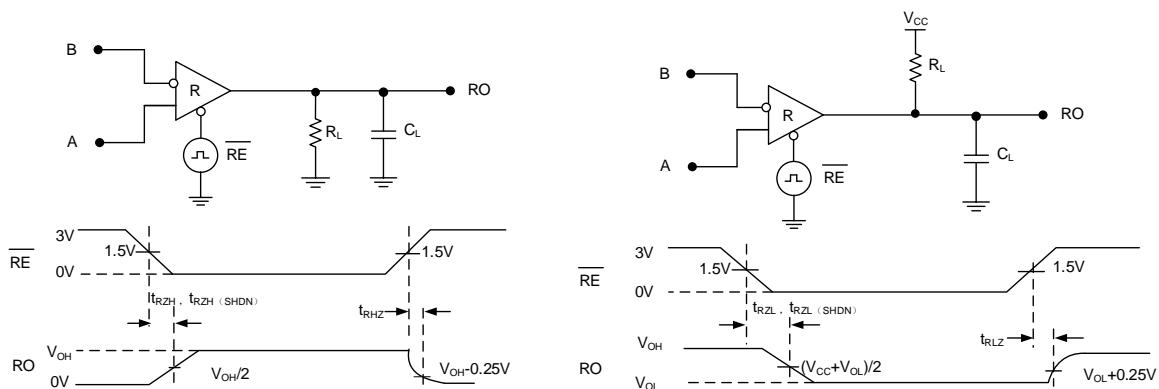
Note2 : The short-circuit output current is the peak current just prior to current limiting; the short-circuit foldback output current applies during current limiting to allow a recovery from bus contention.

Switching Characteristics

($V_{CC} = +3V$ to $+5.5V$, $V_L = +1.65V$ to $+V_{CC}$, $T_A = -40^\circ C$ to $+85^\circ C$, unless otherwise noted.)

| Symbol | Parameter | Test Conditions | Min | Typ | Max | Unit |
|------------------------------------|--|--|-----|-----|------|------|
| Driver AC Characteristics | | | | | | |
| t_{DPLH} | Driver prop delay (low to high) | See Figure3 $R_L=54\ \Omega$, $C_L=50\text{pF}$ | | | 60 | ns |
| t_{DPHL} | Driver prop delay (high to low) | See Figure3 $R_L=54\ \Omega$, $C_L=50\text{pF}$ | | | 60 | ns |
| t_{DSKEW} | Differential Driver Output Skew $ t_{DPLH} - t_{DPHL} $ | See Figure3 $R_L=54\ \Omega$, $C_L=50\text{pF}$ | | | 10 | ns |
| t_{DR} , t_{DF} | Differential Driver Output Rise Time or Fall Time | See Figure3 $R_L=54\ \Omega$, $C_L=50\text{pF}$ | | | 15 | ns |
| f_{MAX} | Maximum Data Rate | Duty Cycle 40% to 60% | | 10 | | Mbps |
| t_{DZH} | Driver Enable to Output High | See Figure4 $R_L=500\ \Omega$, $C_L=50\text{pF}$ | | | 100 | ns |
| t_{DZL} | Driver Enable to Output Low | See Figure4 $R_L=500\ \Omega$, $C_L=50\text{pF}$ | | | 100 | ns |
| t_{DHZ} | Driver Disable from Output High | See Figure4 $R_L=500\ \Omega$, $C_L=50\text{pF}$ | | | 100 | ns |
| t_{DLZ} | Driver Disable from Output Low | See Figure4 $R_L=500\ \Omega$, $C_L=50\text{pF}$ | | | 100 | ns |
| $t_{DZH(SHDN)}$ | Driver Enable from Shutdown to output high | See Figure4 $R_L=500\ \Omega$, $C_L=50\text{pF}$ | | | 5000 | ns |
| $t_{DZL(SHDN)}$ | Driver Enable from Shutdown to output low | See Figure4 $R_L=500\ \Omega$, $C_L=50\text{pF}$ | | | 5000 | ns |
| t_{SHDN} | Time to Shutdown | | | | 1000 | ns |
| Receiver AC Characteristics | | | | | | |
| Symbol | Parameter | Test Conditions | Min | Typ | Max | Unit |
| t_{RPLH} | Receiver prop delay (low to high) | See Figure5 $C_L=15\text{pF}$ | 30 | 60 | 90 | ns |
| t_{RPHL} | Receiver prop delay (high to low) | See Figure5 $C_L=15\text{pF}$ | 30 | 60 | 90 | ns |
| t_{RSKEW} | Differential Receiver Output Skew $ t_{RPLH}-t_{RPHL} $ | $C_L=15\text{pF}$ | | | 10 | ns |
| f_{MAX} | Maximum Data Rate | Duty Cycle 40% to 60% | | 10 | | Mbps |
| t_{RZH} | Receiver enable to output high | See Figure6 $R_L=1k\Omega$, $C_L=15\text{pF}$ | | | 100 | ns |
| t_{RZL} | Receiver enable to output low | See Figure6 $R_L=1k\Omega$, $C_L=15\text{pF}$ | | | 100 | ns |
| t_{RHZ} | Receiver Disable from output high | See Figure6 $R_L=1k\Omega$, $C_L=15\text{pF}$ | | | 100 | ns |
| t_{RLZ} | Receiver Disable from output low | See Figure6 $R_L=1k\Omega$, $C_L=15\text{pF}$ | | | 100 | ns |
| $t_{RZH(SHDN)}$ | Receiver enable from shutdown to output high | See Figure6 $R_L=1k\Omega$, $C_L=15\text{pF}$ | | | 5000 | ns |
| $t_{RZL(SHDN)}$ | Receiver enable from shutdown to output low | See Figure6 $R_L=1k\Omega$, $C_L=15\text{pF}$ | | | 5000 | ns |
| t_{SHDN} | Time to shutdown | | | | 1000 | ns |

Parameter Measurement Information

Figure 1. Differential Driver Output Voltage

Figure 2. Differential Driver Output Voltage Over Common Mode

Figure 3. Driver Propagation Delay Test Circuit and Timing Diagram

Parameter Measurement Information (continued)

Figure 4. Driver Enable and Disable Timing Test Circuits and Timing Diagrams

Figure 5. Receiver Propagation Delay Test Circuit and Timing Diagram

Figure 6. Receiver Enable and Disable Test Circuits and Timing Diagrams

Device Function Table

| Transmitting | | | | |
|--------------|----|----|----------|---|
| Inputs | | | Outputs | |
| RE | DE | DI | A | B |
| X | 1 | 1 | 1 | 0 |
| X | 1 | 0 | 0 | 1 |
| 0 | 0 | X | High-Z | |
| 1 | 0 | X | Shutdown | |

| Receiving | | | |
|-----------|----|--|-----------|
| Inputs | | | Output |
| RE | DE | $V_A - V_B$ | RO |
| 0 | X | $\geq 50\text{mV}$ | 1 |
| 0 | X | $-200\text{mV} < V_A - V_B < -50\text{mV}$ | Undefined |
| 0 | X | $\leq -200\text{mV}$ | 0 |
| 0 | X | Open/Shorted/Idle | 1 |
| 1 | 1 | X | High -Z |
| 1 | 0 | X | Shutdown |

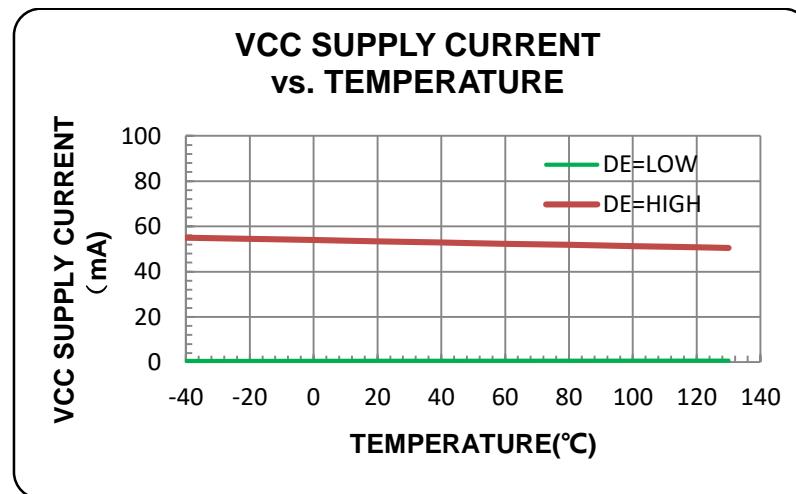
Typical Operating Characteristics


Figure 7. Vcc Supply Current vs. Temperature

Typical Operating Characteristics (continued)

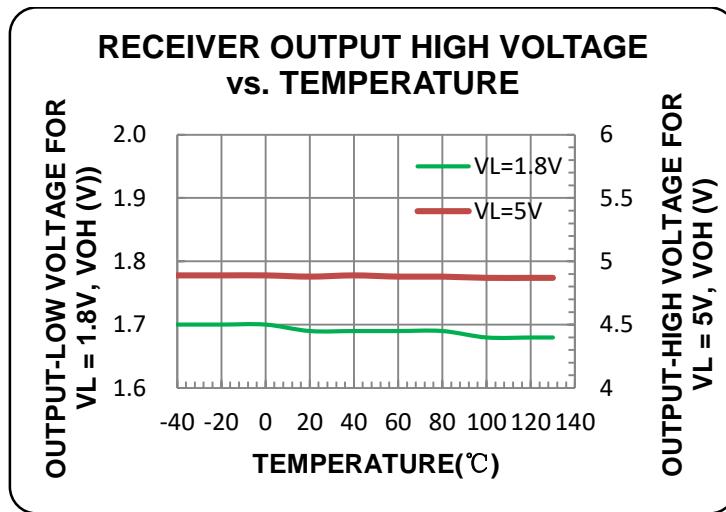


Figure 8. Receiver Output High Voltage vs. Temperature

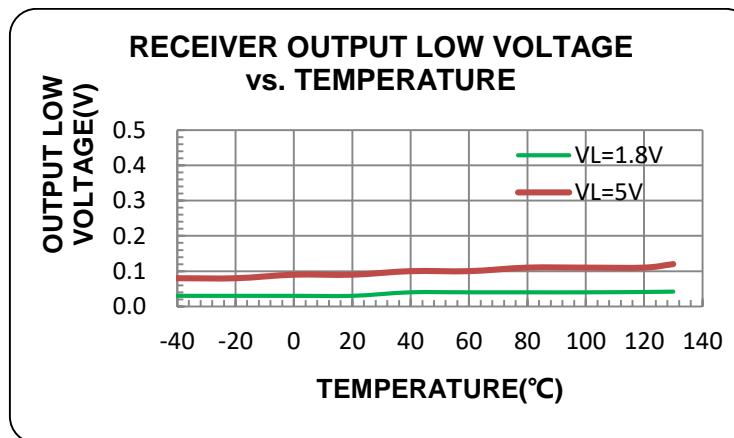


Figure 9. Receiver Output Low Voltage vs. Temperature

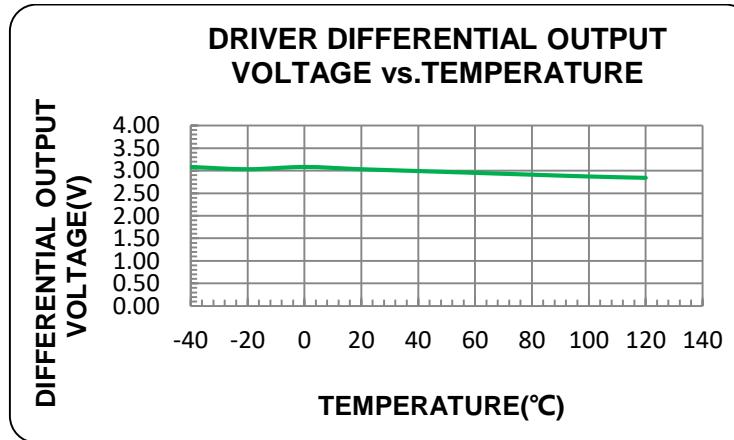


Figure 10. Driver Differential Output Voltage vs. Temperature

Block Diagram

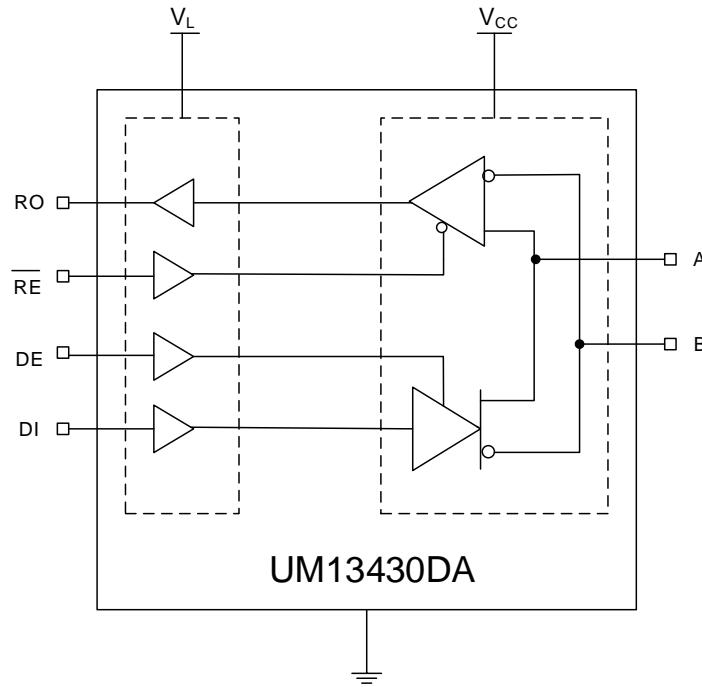


Figure 11. Block Diagram:

Detail Description

The UM13430DA high-speed transceivers for RS-485 communication contain one driver and one receiver. These devices feature fail-safe circuitry, which guarantees a logic-high receiver output when the receiver inputs are open or shorted, or when they are connected to a terminated transmission line with all drivers disabled. The UM13430DA driver slew rates are not limited, making transmit speeds up to 10Mbps possible.

The UM13430DA RS-485 transceivers operate with a V_{CC} voltage supply from 3V to 5.5V. Drivers are output short-circuit current limited. Thermal shutdown circuitry protects drivers against excessive power dissipation. When activated, the thermal shutdown circuitry places the driver outputs into a high impedance state.

Fail-Safe

The UM13430DA guarantees a logic-high receiver output when the receiver inputs are shorted or open, or when they are connected to a terminated transmission line with all drivers disabled. This is done by setting the receiver threshold between -50mV and -200mV. If the differential receiver input voltage ($A-B$) is greater than or equal to -50mV, RO is logic high. If $A-B$ is less than or equal to -200mV, RO is logic low. In the case of a terminated bus with all transmitters disabled, the receiver's differential input voltage is pulled to 0V by the termination. With the receiver thresholds of the UM13430DA, this results in a logic high with a 50mV minimum noise margin. Unlike previous fail-safe devices, the -50mV to -200mV threshold complies with the $\pm 200\text{mV}$ EIA/TIA-485 standard.

Applications Information

256 Transceivers on the Bus

The standard RS-485 receiver input impedance is $12\text{k}\Omega$ (one unit load), and the standard driver can drive up to 32 unit loads. The Union family of transceivers have a 1/8 unit load receiver input impedance ($96\text{k}\Omega$), allowing up to 256 transceivers to be connected in parallel on one communication line. Any combination of these devices and/or other RS-485 transceivers with a total of 32 unit loads or less can be connected to the line.

Driver Output Protection

Two mechanisms prevent excessive output current and power dissipation caused by faults or by bus contention. The first, a foldback current limit on the output stage, provides immediate protection against short circuits over the whole common-mode voltage range. The second, a thermal shutdown circuit, forces the driver outputs into a high-impedance state if the die temperature becomes excessive.

Typical Applications

The UM13430DA transceivers are designed for bidirectional data communications on multipoint bus transmission lines. To minimize reflections, the line should be terminated at both ends in its characteristic impedance, and stub lengths off the main line should be kept as short as possible.

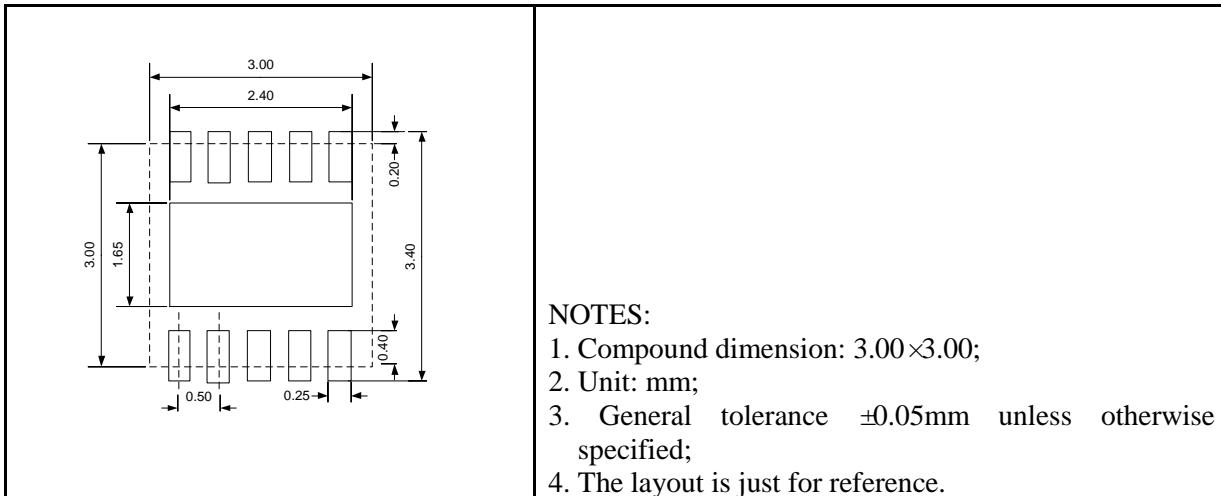
Package Information

UM13430DA DFN10 3.0 × 3.0

Outline Drawing

| Symbol | DIMENSIONS | | | | | |
|--------|-------------|-------|-------|----------|-------|-------|
| | MILLIMETERS | | | INCHES | | |
| | Min | Typ | Max | Min | Typ | Max |
| A | 0.70 | 0.75 | 0.80 | 0.028 | 0.030 | 0.032 |
| A1 | 0.00 | 0.02 | 0.05 | 0.000 | 0.001 | 0.002 |
| A3 | 0.20REF | | | 0.008REF | | |
| b | 0.20 | 0.25 | 0.30 | 0.008 | 0.010 | 0.012 |
| D | 2.90 | 3.00 | 3.10 | 0.116 | 0.120 | 0.124 |
| E | 2.90 | 3.00 | 3.10 | 0.116 | 0.120 | 0.124 |
| D2 | 1.55 | 1.65 | 1.75 | 0.062 | 0.066 | 0.070 |
| E2 | 2.30 | 2.40 | 2.50 | 0.092 | 0.096 | 0.100 |
| e | 0.40 | 0.50 | 0.60 | 0.016 | 0.020 | 0.024 |
| K | 0.175 | 0.275 | 0.375 | 0.007 | 0.011 | 0.015 |
| L | 0.35 | 0.40 | 0.45 | 0.014 | 0.016 | 0.018 |
| R | 0.20REF | | | 0.008REF | | |

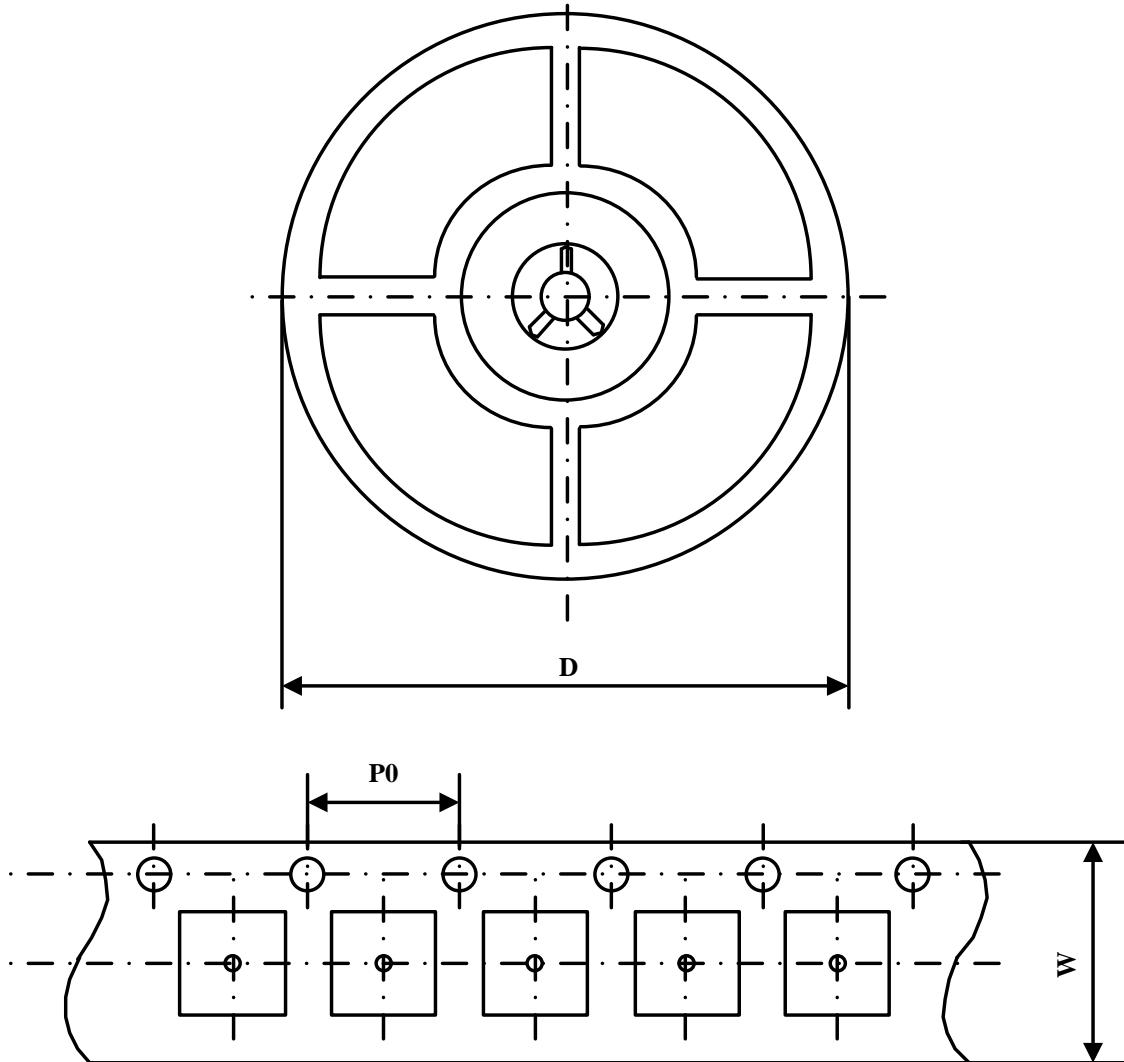
Land Pattern



Tape and Reel Orientation



Packing Information



| Part Number | Package Type | Carrier Width(W) | Pitch(P0) | Reel Size(D) |
|-------------|---------------|------------------|-----------|--------------|
| UM13430DA | DFN10 3.0×3.0 | 12 mm | 4 mm | 330 mm |

GREEN COMPLIANCE

Union Semiconductor is committed to environmental excellence in all aspects of its operations including meeting or exceeding regulatory requirements with respect to the use of hazardous substances. Numerous successful programs have been implemented to reduce the use of hazardous substances and/or emissions.

All Union components are compliant with the RoHS directive, which helps to support customers in their compliance with environmental directives. For more green compliance information, please visit:

http://www.union-ic.com/index.aspx?cat_code=RoHSDeclaration

IMPORTANT NOTICE

The information in this document has been carefully reviewed and is believed to be accurate. Nonetheless, this document is subject to change without notice. Union assumes no responsibility for any inaccuracies that may be contained in this document, and makes no commitment to update or to keep current the contained information, or to notify a person or organization of any update. Union reserves the right to make changes, at any time, in order to improve reliability, function or design and to attempt to supply the best product possible.